



Features

- 3.5mm X 3.5mm X 1.15mm SMD LED
- Zener diode provided for ESD Protection
- IR-reflow compatible
- Ideal for accent lighting
- Standard Package: 2,000pcs / Reel
- MSL (Moisture Sensitivity Level): 2a
- RoHS compliant







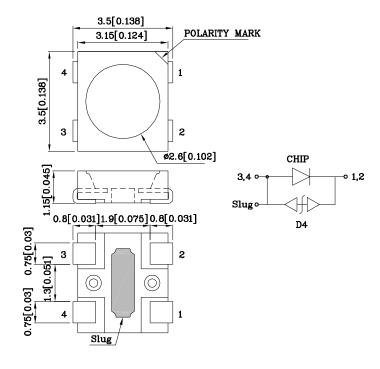
ATTENTION

OBSERVE PRECAUTIONS
FOR HANDLING
ELECTROSTATIC
DISCHARGE
SENSITIVE
DEVICES

Applications

- Signal and symbol luminaire for orientation.
- Marker lights (e.g. steps, exit ways, etc).
- Decorative and entertainment lighting.
- Commercial and residential lighting.
- Automotive interior lighting.

Package Schematics



Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is $\pm 0.25 (0.01")$ unless otherwise noted.
- 3. Specifications are subject to change without notice.

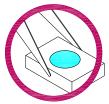


Handling Precautions

Compare to epoxy encapsulant that is hard and brittle, silicone is softer and flexible. Although its characteristic significantly reduces thermal stress, it is more susceptible to damage by external mechanical force.

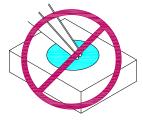
As a result, special handling precautions need to be observed during assembly using silicone encapsulated LED products. Failure to comply might lead to damage and premature failure of the LED.

1. Handle the component along the side surfaces by using forceps or appropriate tools.

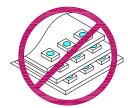


2. Do not directly touch or handle the silicone lens surface. It may damage the internal circuitry.

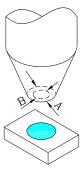




3. Do not stack together assembled PCBs containing exposed LEDs. Impact may scratch the silicone lens or damage the internal circuitry.



- 4.1. The inner diameter of the SMD pickup nozzle should not exceed the size of the LED to prevent air leaks.
- 4.2. A pliable material is suggested for the nozzle tip to avoid scratching or damaging the LED surface during pickup.
- 4.3. The dimensions of the component must be accurately programmed in the pick-and-place machine to insure precise pickup and avoid damage during production.



5. As silicone encapsulation is permeable to gases, some corrosive substances such as H_2S might corrode silver plating of leadframe. Special care should be taken if an LED with silicone encapsulation is to be used near such substances.



Part

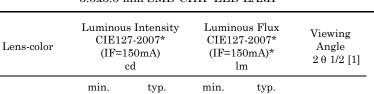
Number

XZCB25X92S-4

Part Number: XZCB25X92S-4

3.5x3.5 mm SMD CHIP LED LAMP

1.295*



2.4*

3.3*

120°

Notes:

1. θ 1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.

Emitting

Material

InGaN

- 2. Luminous intensity / luminous flux: +/-15%.
- 3. LEDs are binned according to their luminous flux.
- * Luminous intensity / luminous flux value is in accordance with CIE127-2007 standards.

Emitting

Color

Blue

Absolute Maximum Ratings at Ta=25°C

Parameter	Symbol	Value	Unit
Power Dissipation	PD	600	mW
Junction Temperature [1]	TJ	110	°C
Operating Temperature	Тор	-40 To +85	°C
Storage Temperature	Tstg	-40 To +85	°C
DC Forward Current[1]	IF	150	mA
Peak Forward Current [2]	IFM	300	mA
Reverse Voltage	VR	5	V
Thermal Resistance [1] (Junction/ambient)	Rth j-a	180	°C/W
Thermal Resistance [1] (Junction/solder point)	Rth j-S	85	°C/W
Electrostatic Discharge Threshold (HBM)		8000	V

Water Clear

0.7*

Notes:

Electrical / Optical Characteristics at Ta=25°C

Parameter	Symbol	Value	Unit
Forward Voltage IF = 150mA [Min.]		2.7	
Forward Voltage I _F = 150mA [Typ.]	V _F [2]	3.5	V
Forward Voltage IF = 150mA [Max.]		4.0	
Allowable Reverse Current [Max.]	Ir	85	mA
Wavelength at peak emission IF=150mA CIE127-2007* [Typ.]	λ peak	445*	nm
Dominant Wavelength IF=150mA CIE127-2007* [Typ.]	λ dom [1]	450*	nm
Spectral bandwidth at 50% Φ REL MAX IF = 150mA [Typ.]	Δλ	20	nm
Temperature coefficient of λ peak $I_F = 150 \text{mA}$, $-10^{\circ}\text{C} \leq T \leq 100^{\circ}\text{C}$ [Typ.]	TC λ peak	0.12	nm/°C
Temperature coefficient of λ dom IF = 150mA, \cdot 10°C \leq T \leq 100°C [Typ.]	TC λ dom	0.10	nm/°C
Temperature coefficient of VF $I_F = 150 mA$, $-10 °C \le T \le 100 °C$ [Typ.]	TCv	-2.3	mV/°C

Notes:

Dec 16, 2013

^{1.}Results from mounting on PC board FR4(pad size≥70mm²), mounted on pc board-metal core PCB is recommend for lowest thermal Resistance.

^{2.1/10} Duty Cycle, 0.1ms Pulse Width.

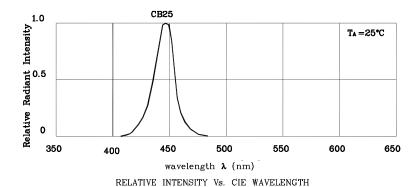
^{1.} The dominant Wavelength (λd) above is the setup value of the sorting machine. (Tolerance λd : ± 1 nm.)

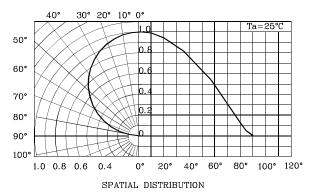
^{2.} Forward Voltage: +/-0.1V.

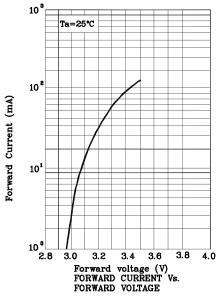
^{*}Wavelength value is in accordance with CIE127-2007 standards.

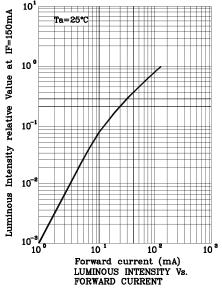


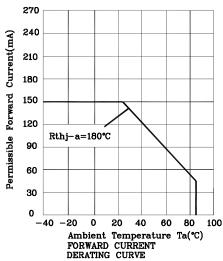


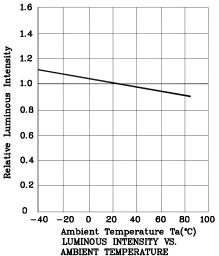










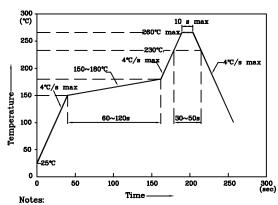




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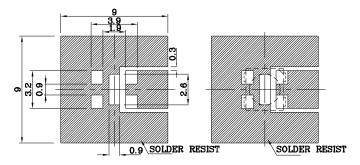
***** LED is recommended for reflow soldering and soldering profile is shown below.

Reflow Soldering Profile for SMD Products (Pb-Free Components)



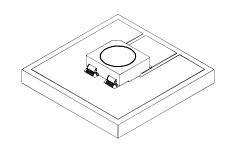
- 1. Maximum soldering temperature should not exceed 260°C $\,$
- 2. Recommended reflow temperature: 145°C-260°C
- 3. Do not put stress to the epoxy resin during high temperatures conditions

* Recommended Soldering Pattern

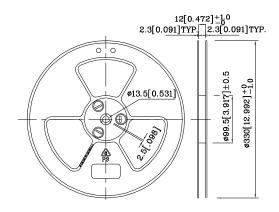


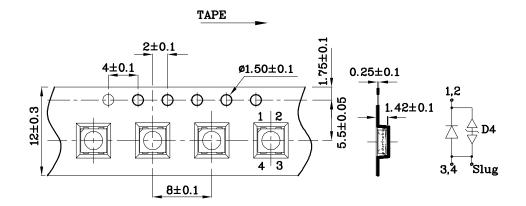
❖ Tape Specification (Units:mm)

❖ The device has a single mounting surface. The device must be mounted according to the specifications.



Reel Dimension

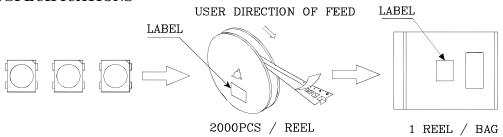


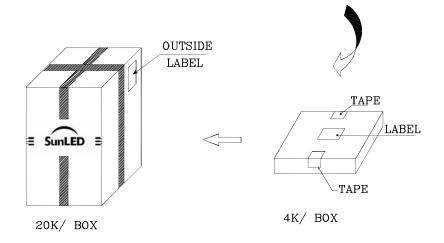


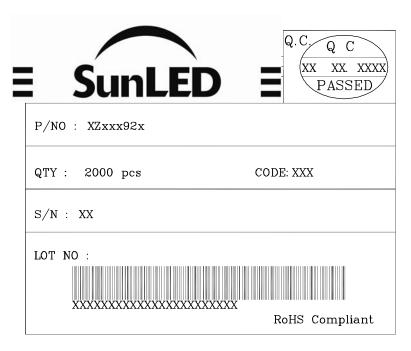




PACKING & LABEL SPECIFICATIONS







TERMS OF USE

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